



Manufacturer:
Epoxy Technology

Product Name:
EPO-TEK® 354-2 High Temperature Epoxy, Heat Cure (4g)

Manufacturer Part Number:
ET354-2-4G

▶ [Click here for more details on the EPO-TEK® 354-2 High Temperature Epoxy, Heat Cure \(4g\)](#)



Product Information Sheet
EPO-TEK® 354-2

Date: November 2025
Rev: IV
No. of Components: Two
Mix Ratio by Weight: 10 : 1
Specific Gravity: Part A: 1.20 Part B: 1.18
Pot Life: 3 Days
Shelf Life- Bulk: One year at room temperature

Recommended Cure: 150°C / 1 Hour
Minimum Alternative Cure(s):
May not achieve performance properties listed below
 150°C / 10 Minutes
 120°C / 30 Minutes
 80°C / 2 Hours

NOTES:

- Container(s) should be kept closed when not in use.
- Filled systems should be stirred thoroughly before mixing and prior to use.
- Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packages.
- Syringe packaging will impact initial viscosity and effective pot life, potentially beyond stated parameters.
- **TOTAL MASS SHOULD NOT EXCEED 25 GRAMS**

Product Description: EPO-TEK® 354-2 is a two component, high Tg epoxy designed for semiconductor packaging in medical, fiber optic and optoelectronic assemblies. It is an electrically and thermally insulating epoxy. It is a replacement for EPO-TEK® 354.

Typical Properties: Cure condition: varies as required Different batches, conditions & applications yield differing results.
 Data below is not guaranteed. To be used as a guide only, not as a specification.
 Information is Preliminary While Specifications Are Being Developed. * denotes test on lot acceptance basis

PHYSICAL PROPERTIES:		
	Part A: Clear/Colorless	Part B: Dark Amber
*Color (before cure):	Pourable liquid	
*Consistency:	7,415 cPs	
*Viscosity (23°C) @ 20 rpm:	N/A	
Thixotropic Index:	123 °C (Dynamic Cure: 20-200°C/ISO 25 Min; Ramp -10-200°C @20°C/Min)	
*Glass Transition Temp:	80.8 x 10 ⁻⁶ in/in°C	
Coefficient of Thermal Expansion (CTE):	Below Tg:	297.4 x 10 ⁻⁶ in/in°C
	Above Tg:	83
Shore D Hardness:	1018 psi	
Lap Shear @ 23°C:	≥20 Kg 7112 psi	
Die Shear @ 23°C:	430 °C	
Degradation Temp:		
Weight Loss:	@ 200°C:	0.05 %
	@ 250°C:	0.10 %
	@ 300°C:	0.20 %
Suggested Operating Temperature:	<300 °C (Intermittent)	
Storage Modulus:	259762.6 psi	
Particle Size:	N/A	

ELECTRICAL AND THERMAL PROPERTIES:		
Thermal Conductivity:	N/A	
Volume Resistivity @ 23°C:	≥1 x 10 ¹⁶ Ohm-cm	
Dielectric Constant (1KHz):	3.21	
Dissipation Factor (1KHz):	0.005	

OPTICAL PROPERTIES @ 23°C:		
Spectral Transmission:	>95% @ 600-2100 nm	
Refractive Index:	1.5759 nm	

This information is based on data and tests believed to be accurate. Epoxy Technology, Inc. makes no warranties (expressed or implied) as to its accuracy and assumes no liability in connection with any use of this product.

Contact the professionals at Fiber Optic Center for a quote or to get more details.

focenter.com • 508-992-6464 | (800) 473-4237 • sales@focenter.com

23 Centre Street • New Bedford, MA 02740 USA

Product specifications and data are subject to change without notice. FOC last update 2/12/2026.